

## **UPDATE CHANGE NOTIFICATION # 16630**

Generic Copy

Issue Date: 10-Aug-2011

TITLE: Update to the FPCN Dual source LM317 and NCV317 in EPI44 and ON50 Process

Technology

PROPOSED FIRST SHIP DATE: 10-Aug-2011

AFFECTED CHANGE CATEGORY(S): Wafer Fab Process

**ADDITIONAL RELIABILITY DATA:** N/A

**SAMPLES:** Contact your local ON Semiconductor Sales Office

#### FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or <a href="mailto:sales.org">Jaroslav.Supina@onsemi.com</a>>

### **NOTIFICATION TYPE:**

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <quality@onsemi.com>.

## **DESCRIPTION AND PURPOSE:**

FPCN # 16630 was published on May 9, 2011 which notified customers of the qualification of the LM317 device family on the new ON50 wafer process technology. The FPCN stated an incorrect implementation date of ww44 (6 month) instead of the normal WW33 (3 Month) notification period. The purpose of this update notice is to correct the changed part identification information.

Parts with date code of WW33-2011 or greater may be sourced from either die technology line.

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# **List of affected General Parts:**

**PART** 

LM317BTG LM317TG LM317BD2TG LM317BD2TR4G LM317D2TG LM317D2TR4G LMW317 SCD317BTG

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